

OPTIGA™ Authenticate Family

Description

This short data sheet describes the OPTIGA[™] Authenticate S authentication device together with its features and functionality.

Features

Authentication

- 163-bit Elliptic Curve Cryptography (ECC) Engine
- 193-bit OPTIGA Digital Certificate (ODC)
- Message Authentication Code (MAC) function for user data authentication
- MAC based Host Authentication (selected sales codes)
- Customizable kill (end-of-life) features
- Unique Chip ID 96-bit

Non-Volatile Memory

- Lockable User NVM memory
- 32-bit page granularity
- Lifespan indicator

Communication Interface

- I2C I/O interface
- SWI I/O interface
- GPO as output interface

Package

Package PG-TSNP-6-12

ESD

- JESD22-A114 ESD HBM 2KV standard
- JESC-C101 ESD CDM 500V standard
- IEC-61000-4-2 contact discharge 8KV for I/O pins
- IEC-61000-4-2 air discharge 15KV for I/O pins

Software

Host-side library



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1 Overview

1.1 Product Description

Infineon Technologies' novel OPTIGA[™] Authenticate S Authentication chip offers a robust cryptographic solution that assists OEMs and system manufacturers to ensure the authenticity and safety of their original products, and protection of their investments against unauthorized after-market replacements. It leverages Infineon's market leading security know-how into the battery and accessory authentication markets. With its innovative asymmetric cryptography approach, it significantly reduces system cost whilst making a leap in security.

1.2 Functional Overview

OPTIGA[™] Authenticate S is designed to be used as a companion authentication device. This authentication device resides away from the host system such that the host system is able to check if it is communicating with an authenticated original device.

OPTIGA[™] Authenticate S supports a configurable I2C interface and SWI interface to communicate with the Host controller. It is designed to conform to the I2C- bus specification and the Infineon SWI Bus Interface specification. The configuration of the interface link for the OPTIGA[™] Authenticate S can be configured in the application board.

1.3 Typical Application

OPTIGA[™] Authenticate S can be integrated into a host system supporting I2C interface as shown in Figure 1. It operates as an I2C slave device supporting 100 kHz and 400 kHz operating frequency. Depending on the selected frequency, the appropriate pull-up resistors need to be applied. I2C uses two wires to transmit data synchronously. One of the wires (SCL) carries the clock signal that is controlled by the I2C master and the other wire (SDA) is used to send and receive data. I2C is a widely used protocol and the transmission protocol is well-defined and well supported by many hardware architectures [1].

Apart from I2C communication support, OPTIGA[™] Authenticate S also supports the Infineon SWI protocol. It requires only a single GPIO for input and output. A pull-up resistor, R_p, is required for the open-drain configuration. OPTIGA[™] Authenticate S provides a combination of secured authentication function and user read/write storage space via a single serial interface (SWI). SWI is able to perform bidirectional communication on multiple devices on the bus without extra hardware. Communication on the SWI is using half-duplex transmission in which master and slave cannot transmit and receive commands concurrently. In the SWI architecture, an SWI master initiates and controls all the SWI operations. The SWI bus operates in command and response sequences. An additional feature of the SWI interface is the ability of interrupt-based processing which allows for concurrent processing.

Below figures show examples of a host system connection to an OPTIGA[™] Authenticate S device in I2C and SWI configurations.

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Overview

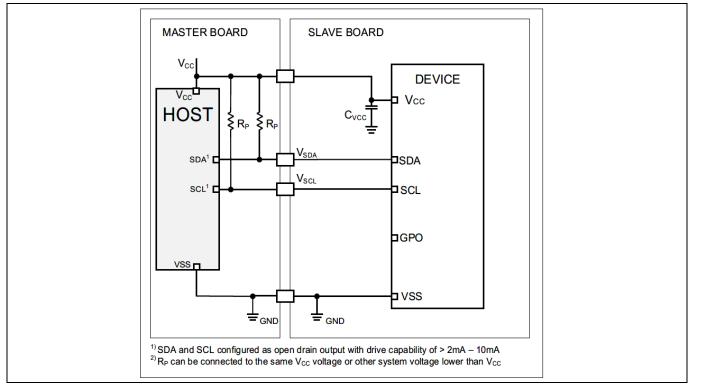


Figure 1 Application diagram of OPTIGA[™] Authenticate S with I2C connectivity

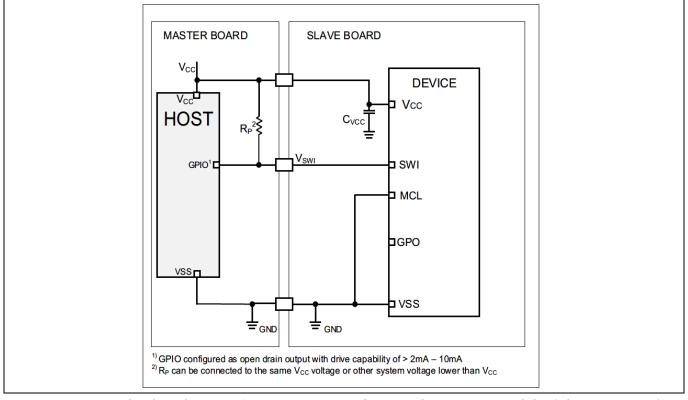


Figure 2 Application diagram of OPTIGA[™] Authenticate S with SWI connectivity (direct powered)





Overview

In another typical application, OPTIGA[™] Authenticate S can operate in indirect power mode where it is powered up by the communication line and is maintained powered during the communication transaction through the SWI communication. The resistor, R_P, maintains the power supply with a voltage drop of R_P multiplied by I_P. The voltage is fed to the OPTIGA[™] Authenticate S's single wire interface port and its power supply through a diode.

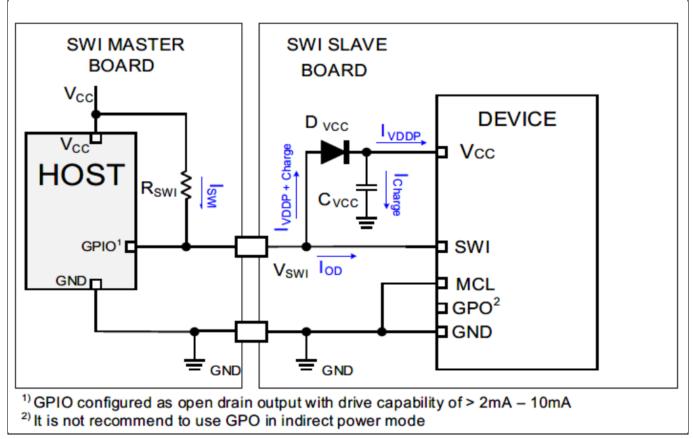


Figure 3 Application diagram of OPTIGA[™] Authenticate S with SWI connectivity (Indirect powered)



OPTIGA[™] Authenticate Family

Device Types/Order Information

2 Device Types/Order Information

The OPTIGA[™] Authenticate S is available in the following standard temperature range shown in Table 1 and extended temperature range shown in Table 2.

Table 1 Device Configuration for standard temperature

Device Name	Package	Remarks
SLE95401	PG-TSNP-6-12	1Kbit User NVM
SLE95402	PG-TSNP-6-12	2Kbit User NVM
SLE95405	PG-TSNP-6-12	5Kbit User NVM
SLE95411	PG-TSNP-6-12	Host Authentication with 1Kbit User NVM
SLE95412	PG-TSNP-6-12	Host Authentication with 2Kbit User NVM
SLE95415	PG-TSNP-6-12	Host Authentication with 5Kbit User NVM

Table 2Device Configuration for extended temperature

Device Name	Package	Remarks
SLE95401	PG-TSNP-6-12	1Kbit User NVM
SLE95402	PG-TSNP-6-12	2Kbit User NVM
SLE95405	PG-TSNP-6-12	5Kbit User NVM
SLE95411	PG-TSNP-6-12	Host Authentication with 1Kbit User NVM
SLE95412	PG-TSNP-6-12	Host Authentication with 2Kbit User NVM
SLE95415	PG-TSNP-6-12	Host Authentication with 5Kbit User NVM

OPTIGA™ Authenticate Family



Signals Description

3 Signals Description

OPTIGA[™] Authenticate S is delivered in a PG-TSNP-6-12 package.

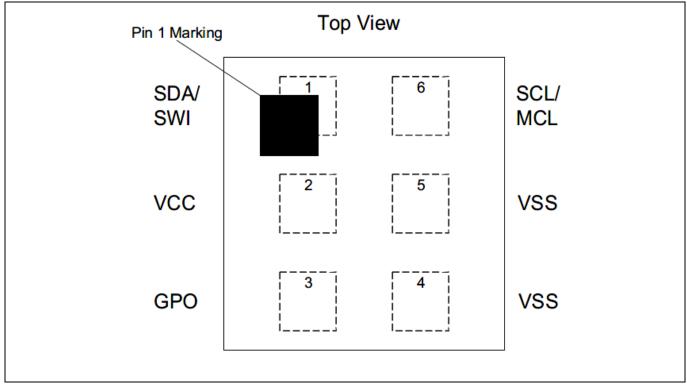


Figure 4 Pin configuration of OPTIGA[™] Authenticate S

Table 3I/O Signals

Pin No.	Name	Pin Type	Buffer Type	Function
1	SDA/SWI	I/O	OD	Serial Data (I2C Configuration) SWI
6	SCL/MCL	I	OD	Serial Clock (I2C Configuration) Must be connected to LOW (SWI Configuration)
3	GPO	0	PP	GPO

Table 4Power Supply

Pin No.	Name	Pin Type	Buffer Type	Function			
2	V _{cc}	PWR	-	Positive Power Input for device			

Table 5Ground Pins

Pin No.	Name	Pin Type	Buffer Type	Function
4,5	VSS	PWR	-	GND Pin
				This is the common ground of the IC. Pin 4 is the main ground of the package

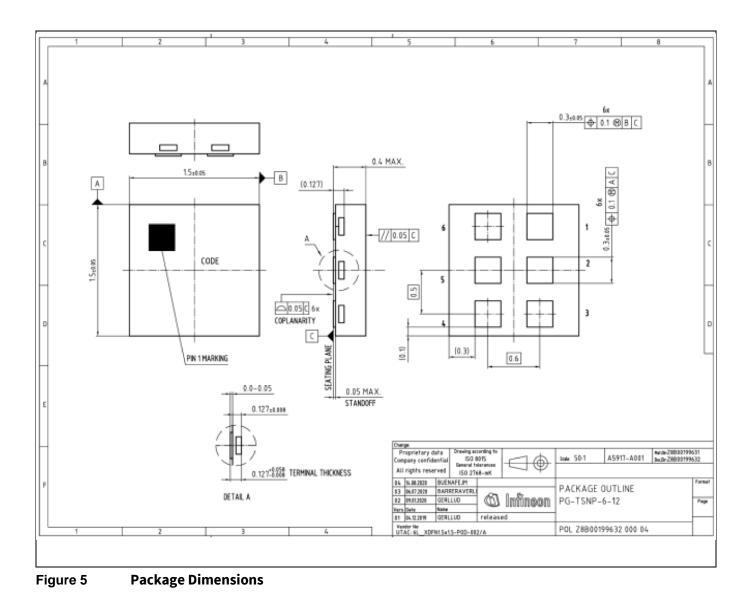
OPTIGA[™] Authenticate Family



Signals Description

Table 6 PG-TSNP-6-12 Package Dimensions

Parameter	Symbol	Symbol Values			Unit	Note or Test
		Min	Тур	Max		Condition
A		1.45	1.50	1.55	mm	Package Width
В		1.45	1.50	1.55	mm	Package Length
		0.35	0.38	0.40	mm	Package Height
AC		0.25	0.30	0.35	mm	Solder Pad Width
BC		0.25	0.30	0.35	mm	Solder Pad Length
			0.60		mm	Solder Pad Pitch - X
			0.50		mm	Solder Pad Pitch - Y





Packing Specification

4 Packing Specification

4.1 Package Marking

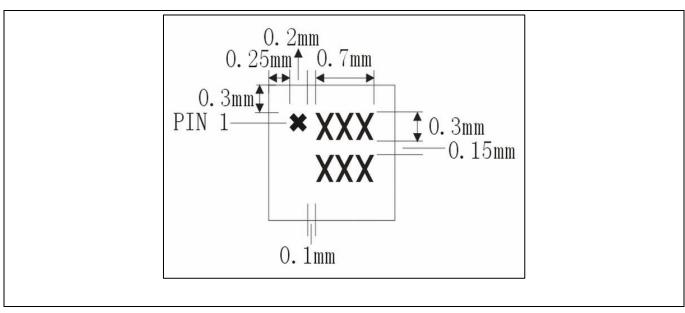


Figure 6 PG-TSNP-6-12 package marking and dimensions

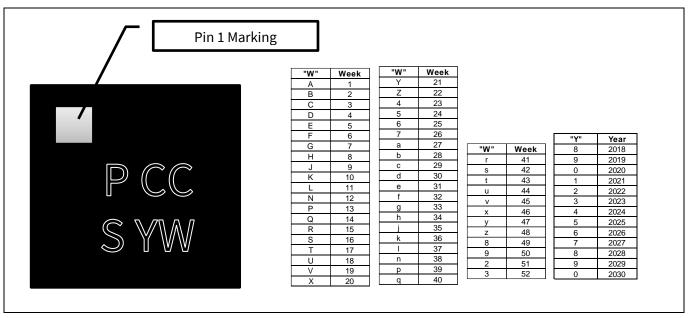


Figure 7 Package laser marking

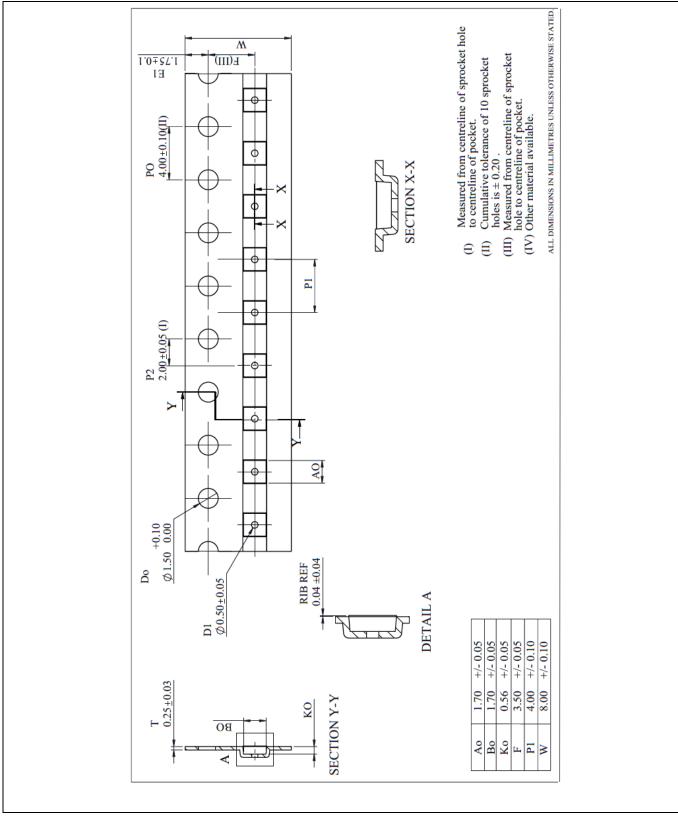
P refers to product number and CC refers to delivered customer code. S refers to sample code. YW refers to date code. The date code can be decoded using the supplied table.

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Packing Specification

4.2 Emboss Carrier Tape

Each box contains a single reel with 5000 pieces. Reel diameter is 180 mm.

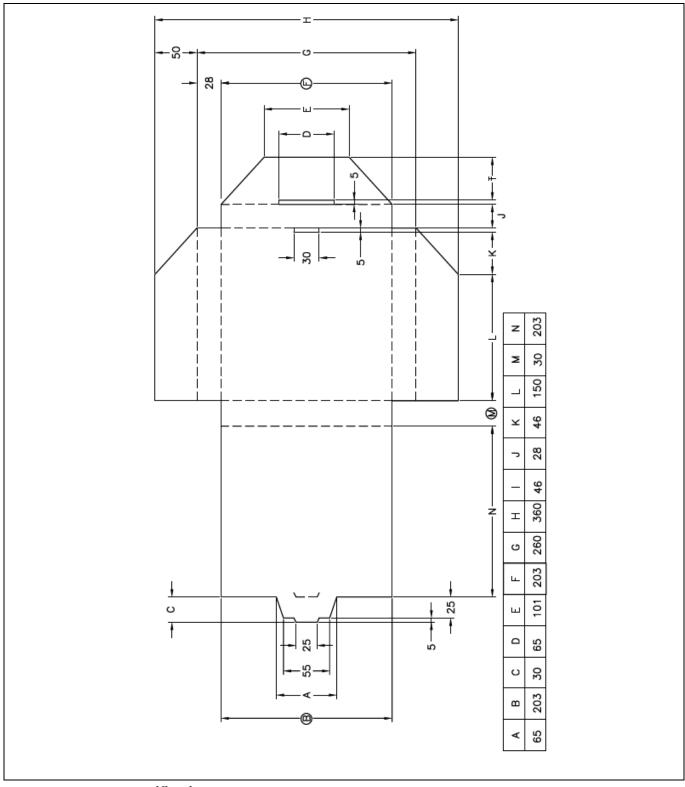




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Packing Specification







OPTIGA™ Authenticate Family

Packing Specification



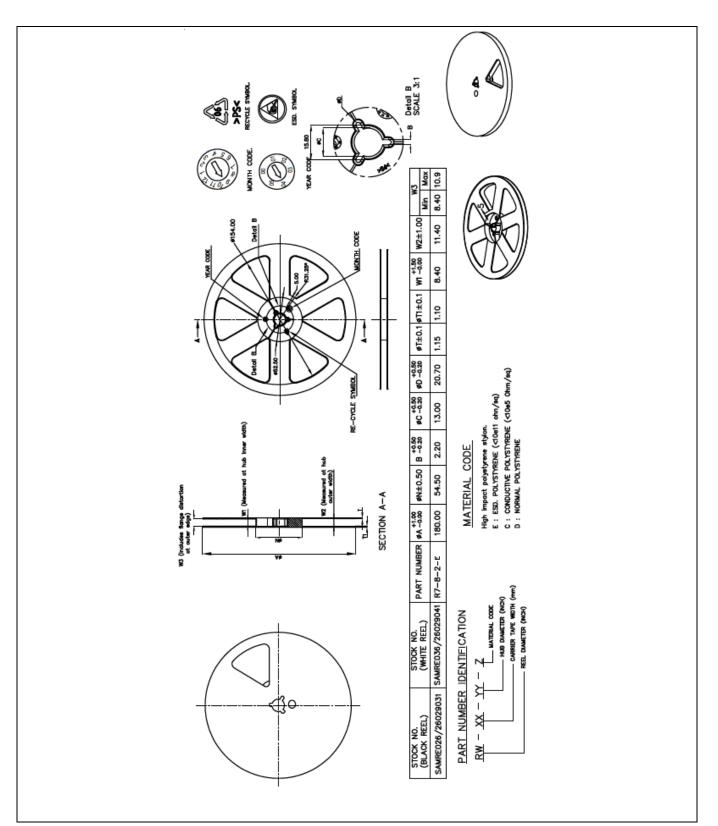


Figure 10 7-inch reel specification



5 Electrical Characteristics

5.1 Absolute Maximum Ratings

Stresses above the maximum values listed here may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Maximum ratings are absolute ratings; exceeding only one of these values may cause irreversible damage to the integrated circuit.

Table 7 Absolute Maximum Ratings

Deverseder	Cymhal		Values		11	Note / Test Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
VCC Supply Voltage	V _{cc}	-0.3	-	6.0	V	
SCL Voltage	$V_{ m SCL}$	-0.3	-	6.0	V	
SDA Voltage	V _{SDA}	-0.3	-	6.0	V	
ESD robustness HBM	$V_{\rm esd,hbm}$	2000			V	According to JS-001- 2012
ESD robustness CDM	$V_{\rm esd,cdm}$	500			V	According to JS-002- 2018
Latch up	$I_{\rm LU}$	100			mA	According to EIA/ JESD78
Storage Temperature	<i>T</i> _{STORE}	-55		150	°C	



OPTIGA™ Authenticate Family Electrical Characteristics

5.2 Operating Conditions

Within the operational range, the IC operates as explained in the product description. Typical Values: $V_{\rm CC}$ =3.8V, $T_{\rm AMB}$ =25 °C

Table 8 Operating Conditions

Daramatar	Symbol	Values			Unit	Note / Test Condition
Parameter	Symbol	Min. Typ. Max.		Unit		
VCC supply voltage range	V _{cc}	1.8	3.8	5.5	v	Measurement is at the V _{cc} pin. Ramp up of V _{cc} shall be slower than 1µs
SCL voltage range	$V_{ m SCL}$	-0.3		5.5	V	For I2C interface only
SDA voltage range	V_{SDA}	-0.3		5.5	V	For I2C interface only
Current consumption, active idle mode	$I_{ m VCC,Active-Idle}$		0.38		mA	Idle Function Mode Averaged over 1s
Current consumption, active mode, authentication operation	$I_{ m VCC,Active-ECC}$		1.2		mA	Averaged over Authentication
Current consumption, active mode, host authentication operation	$I_{ m VCC,Active-HA}$		1.2		mA	Averaged over Authentication
Current consumption, power- down mode	$I_{ m VCC,PD}$		1.0		μΑ	SDA is set at 0V Maximum value condition is set at V _{cc} = 4.35V @ 85 °C
Ambient temperature	T_{AMB}	-40	25	85	°C	
Ambient temperature	$T_{\mathrm{AMB,110}}$	-40	25	110	°C	
Ambient temperature	T _{AMB,120}	-40	25	120	°C	NVM Write Operation is prohibited above 110°C
Power-down low time	t_{PDL}	225.0			μs	
Power-up delay	<i>t</i> _{PUD}			10.0	ms	
Power-up delay	t _{PUD}			5.0	ms	From 0 °C to 40 °C
Soft reset delay	t_{SRD}			1.0	ms	

5.3 I2C Interface Characteristics (Standard Mode)

The table below defines the Standard Mode operation of the I2C interface. The I2C interface characteristics have been extracted from the I2C-bus specification.

 Table 9
 I2C Interface Characteristics (Standard Mode)

Daramatar	Symbol	Values			11	Note / Test Candities
Parameter	Symbol	Min.	Typ. Max.		Unit	Note / Test Condition
Low-Level input voltage	VIL	-0.3		0.3*V _{cc}	V	
High-Level input voltage	V _{IH}	0.7*V _{cc}		1)	V	
Low-Level output voltage 1	V _{OL,1}			0.4	V	Open Drain or Open Collector at 3mA sink current; V _{cc} > V _{cc(min)}



Electrical Characteristics

Parameter	Symbol	Values			Unit	Note / Test Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Low-Level output current	I _{OL}	3.0			mA	$V_{OL} = 0.4V$
Output fall time from $V_{\text{IH}(\text{MIN})}$ to $V_{\text{IL}(\text{MAX})}$	t _{oF}			250 ²⁾	ns	
Input current for SDA/SCL pin	I ₁	-10.0		10	μΑ	$0.1V_{CC} < V_{I} < 0.9V_{CC(MAX)}$
Capacitance for SDA/SCL pin	C1 ³⁾			10	рF	

- 1) Maximum $V_{IH}=V_{CC(MAX)}$ + 0.5V or 5.5V whichever is lower
- 2) The maximum t_F for the SDA and SCL bus lines quoted in the below table (300ns) is longer than the specified maximum t_{OF} for the output stages (250ns). This allows a series protection resistor to be connected between SDA/SCL pins and the SDA/SCL bus lines without exceeding the maximum specified t_F .
- 3) Special purpose devices such as multiplexers and switches may exceed this capacitance because they connect multiple paths together

5.4 I2C Interface Timing Characteristics (Standard Mode)

The table below defines the interface timing characteristics for Standard Mode operation of the I2C interface. These have been extracted from the I2C-bus specification.

Daramatar	Symbol	Values			Unit	Noto / Tost Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
SCL Clock Frequency	f _{scl}	0.0		100.00	kHz	
Hold time (repeated) START condition	t _{hd,sta}	4.0			μs	After this period, the first clock pulse is generated
Low Period for SCL	t_{LOW}	4.7			μs	
High Period for SCL	t _{HIGH}	4.0			μs	
Setup Time for a repeated START Condition	$\mathbf{t}_{\text{su,sta}}$	4.7			μs	
Data Hold Time	t _{hd,dat}	0.0			μs	
Data Setup Time	t _{su,dat}	250.0			ns	
Rise time for SCL or SDA	t _R			1000	ns	Applicable to Master
Fall time for SCL or SDA	t⊧			300	ns	
Setup time for STOP Condition	t _{su,sto}	4.0			μs	
Bus Free Time between STOP and START Condition	t_{BUF}	4.7			μs	
Capacitance load for each bus line	C _b			400.0	pF	
Data valid time	$t_{\text{VD;DAT}}$			3.45 ²⁾	μs	
Data valid acknowledge time	$t_{\text{VD};\text{ACK}}$			3.45 ²⁾	μs	
Noise margin at the LOW level	V _{nL}	0.1*V _{cc}			V	For each connected device (including hysteresis)

 Table 10
 I2C Interface Timing Characteristics (Standard Mode)



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Electrical Characteristics

Parameter	Symbol		Values			Note / Test Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test condition
Noise margin at the HIGH level	V_{nH}	0.2*V _{cc}			V	For each connected device (including hysteresis)

- 1) A device must internally provide a hold time of at least 300 ns for the SDA signal (with respect to the V_{IH(MIN)} of the SCL signal) to bridge the undefined region of the falling edge of SCL.
- 2) The maximum $t_{HD;DAT}$ could be 3.45 us for Standard-mode, but must be less than the maximum of $t_{VD;DAT}$ or $t_{VD;ACK}$ by a transition time. This maximum must only be met if the device does not stretch the LOW period (t_{LOW}) of the SCL signal. If the clock stretches the SCL, the data must be valid before it releases the clock.

5.5 I2C Interface Characteristics (Fast Mode)

The table below defines the Fast Mode operation of the I2C interface. The I2C interface characteristics have been extracted from the I2C-bus specification.

Devenuedev	Cumhal		Values	5	11	Note / Test Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Low-Level input voltage	VIL	-0.3		0.3*V _{cc}	V	
High-Level input voltage	V _{IH}	0.7*V _{cc}		1)	V	
Hysteresis of Schmitt trigger inputs	V_{HYS}	0.05*V _{cc}			V	
Low-Level output voltage 1	V _{OL,1}	0.0		0.4	V	Open Drain or Open Collector at 3mA sink current; V _{cc} > V _{cc(min)}
Low-Level output voltage 2	V _{OL,2}	0.0		0.2*V _{cc}	V	Open Drain or Open Collector at 2mA sink current ²⁾ ; V _{cc} <=V _{CC(MIN)}
Low Lovel output current	-	3.0			mA	$V_{OL} = 0.4V$
Low-Level output current	I _{OL}	6.0			mA	$V_{OL} = 0.6 V^{3)}$
Output fall time from $V_{\text{IH}(\text{MIN})}$ to $V_{\text{IL}(\text{MAX})}$	t_{OF}	20*(V _{cc} / 5.5V) ⁴⁾		250 ⁵⁾	ns	
Pulse width of spikes that must be suppressed by the input filter	t_{SP}			50 ⁶⁾	ns	
Input current for SDA/SCL pin	I,	-10.0		10	μΑ	$0.1^*V_{CC} < V_I < 0.9^*V_{CC(MAX).}$ If V_{CC} is switched off, I/O pins must not obstruct the SDA and SCL lines.
Capacitance for SDA/SCL pin	C			10	pF	

Table 11 I2C Interface Characteristics (Fast Mode)

- 1) Maximum $V_{IH}=V_{CC(MAX)}$ + 0.5V or 5.5V whichever is lower
- 2) The same resistor value to drive 3mA at 3.0V V_{cc} provides the same RC time constant when using < 2V VCC with a smaller current draw.

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Electrical Characteristics

- 3) In order to drive full bus load at 400kHz, 6mA I_{OL} is required at 0.6V V_{OL}. Parts not meeting this specification can still function, but not at 400kHz and 400pF.
- 4) Necessary to be backwards compatible with Fast-Mode. For Fast-Mode Only.
- 5) The maximum t_f for the SDA and SCL bus lines quoted in the below table (300ns) is longer than the specified maximum t_{oF} for the output stages (250ns). This allows a series protection resistor to be connected between SDA/SCL pins and the SDA/SCL bus lines without exceeding the maximum specified t_F.
- 6) Special purpose devices such as multiplexers and switches may exceed this capacitance because they connect multiple paths together

5.6 I2C Interface Timing Characteristics (Fast Mode)

The table below defines the interface timing characteristics for Fast Mode operation of the I2C interface. These have been extracted from the I2C-bus specification.

Darameter	Symbol		Value	5	Unit	Note / Test Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	
SCL clock frequency	f _{scl}	0.0		400.00	kHz	
Hold time (repeated) START condition	t _{hd,sta}	0.6			μs	After this period, the first clock pulse is generated
Low period for SCL	t_{LOW}	1.3			μs	
High period for SCL	t _{HIGH}	0.6			μs	
Setup time for a repeated START Condition	t _{su,sta}	0.6			μs	
Data hold time	t _{hd,dat}	0.01)			μs	
Data setup time	t _{su,dat}	100.0 ³⁾			ns	
Rise time for SCL or SDA	t _R	20.0		330.00	ns	Applicable to Master
Fall time for SCL or SDA	t _F	20*(V _{cc} / 5.5V)		300.00	ns	
Setup time for STOP Condition	t _{su,sto}	0.6			μs	
Bus free time between STOP and START conditions	$t_{\scriptscriptstyle BUF}$	1.3			μs	
Capacitance load for each bus line	C _b			400.0	pF	
Data valid time	$t_{VD;DAT}$			0.9 ²⁾	μs	
Data valid acknowledge time	t _{vd;ACK}			0.92)	μs	
Noise margin at the LOW level	V _{nL}	0.1*V _{cc}			V	For each connected device (including hysteresis)
Noise margin at the HIGH level	V _{nH}	0.2*V _{cc}			V	For each connected device (including hysteresis)

 Table 12
 I2C Interface Timing Characteristics (Fast Mode)

1) A device must internally provide a hold time of at least 300 ns for the SDA signal (with respect to the V_{IH(MIN)} of the SCL signal) to bridge the undefined region of the falling edge of SCL.

2) The maximum $t_{HD;DAT}$ could be 0.9us for Fast-mode, but must be less than the maximum of $t_{VD;DAT}$ or $t_{VD;ACK}$ by a transition time. This maximum must only be met if the device does not stretch the LOW period (t_{LOW}) of the SCL signal. If the clock stretches the SCL, the data must be valid before it releases the clock.





Electrical Characteristics

3) A Fast-mode I2C-bus device can be used in a Standard-mode I2C-bus system, but the requirement $t_{SU;DAT}$ 250ns must then be met. This will automatically be the case if the device does not stretch the LOW period of the SCL signal. If such a device does stretch the LOW period of the SCL signal, it must output the next data bit to the SDA line $t_{r(MAX)} + t_{SU;DAT} = 1000$ acknowledge timing.

5.7 SWI I/O Characteristics

Table 13 SWI I/O Characteristics

Devenuenter	Gumbal		Values		Unit	Note / Test Condition
Parameter	Symbol	Min.	Тур.	Max.		
SWI input high voltage	$V_{ m SWI,IH}$	1.2			V	V _{swi} should be lower than V _{cc}
SWI input low voltage	$V_{ m SWI,IL}$			0.8	V	
SWI output high voltage	$V_{ m swi, oh}$	1.30			V	No indirect powering, measured at 1.0µA. For Master Only
SWI output low voltage	$V_{ m SWI,OL}$			0.1	V	Measured at 1mA
SWI bus load	C _{SWI,L}			250	pF	

5.8 SWI Timing Characteristics

Table 14 SWI Timing Characteristics

Parameter	Symbol		Values		11	Note / Test Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	
Basic Timing Parameters						
Time base	t _{swi}	1.0		50	μs	
Bus frequency	$f_{\sf SWI}$	10.0		500.0	kHz	50% Zero, 50% One
Peak data rate				500	kBit/s	
Bus rise time	tr			200	ns	
Bus fall time	t _f			200	ns	
Transmit Timing Parameters						
Duration for 0 _B	t _{TO}	0.75		1.25	t _{swi}	
Duration for 1_{B}	t _{T1}	2.75		3.25	t _{swi}	
Duration for STOP	t _{TS}	6.00			t_{SWI}	
Receive Timing Parameters						
Duration for 0 _B	t _{RO}	0.6	1.0	1.4	t_{SWI}	
Duration for 1 _B	t _{R1}	2.6	3.0	3.4	t _{swi}	
Duration for STOP	t _{RS}	4.5			t _{swi}	
Interrupt Timing Parameters						
Interrupt arming time	t _{ARM}	4.75			t _{swi}	
Interrupt active time	t _{INT}	0.75	1	1.25	t _{swi}	Drive period for all Slaves



Electrical Characteristics

Darameter	Symbol Min.		Values		Unit	Note / Test Condition
Parameter		Min.	Тур.	Max.	Unit	
Interrupt trailing time	t _{TRAIL}			3.25	t _{swi}	Drive period for all Slaves

Bus Time-Out Parameters

t_{TOUT}		44.0	t _{swi}	Please take note for Time Base, t _{swi} equal to 1µs.
t _{TOUT}		22.0) t _{swi}	Please take note for Time Base, t _{swi} equal to 2µs.
t _{TOUT}		14.0) t _{swi}	Please take note for Time Base, t _{swi} equal to 3μs.
t _{tout}		12.0) t _{swi}	Please take note for Time Base, t _{swi} equal to above 3µs.
t _{tout}		10.0) t _{swi}	Please take note for Time Base, t _{sw} equal to above 5µs.
Parameters				
t_{PDL}	225.0		μs	
	t_{TOUT} t_{TOUT} t_{TOUT} Parameters	t _{тоит}	t _{тоит} 22.0 t _{тоит} 14.0 t _{тоит} 12.0 t _{тоит} 10.0 Parameters 22.0	t _{TOUT} 22.0 t _{SWI} t _{TOUT} 14.0 t _{SWI} t _{TOUT} 12.0 t _{SWI} t _{TOUT} 10.0 t _{SWI} Parameters 10.0 t _{SWI}

Table 15 GPO

Devementer	Cumhal		Values	;	Unit	Note / Test Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
GPO output high Voltage	$V_{\text{GPO,OH}}$	V_{GPO} -0.7			V	Measured at 1mA
GPO output low Voltage	$V_{\text{GPO,OL}}$			0.1	V	Measured at 1mA
GPO internal pull-up resistance	R _{PU(INT)}	50	100	150	kΩ	
GPO internal pull-down resistance	R _{pd(INT)}	50	100	150	kΩ	
GPO frequency	\mathbf{f}_{GPO}			1	MHz	10%/90% V _{cc} , C _{LOAD} =25pF
GPO rise time	t _{GPO,r}			15	ns	V _{cc} =3.8V, C _{LOAD} = 25pF, 10%/90% of V _{cc}
GPO fall time	$t_{\text{GPO.f}}$			15	ns	V _{cc} =3.8V, C _{LOAD} = 25pF, 10%/90% of V _{cc}
GPO load capacitance	C_{LOAD}			25	рF	



5.9 Random Number Generation Time

Table 16Random Number Generation Time

Darameter	Symbol		Values			Note / Test Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Random number generation time	T _{RNG}		55.0	60.0	μs		

OPTIGA™ Authenticate Family



Electrical Characteristics

5.10 Host Authentication Response Computation Time

Davamatar	Symbol		Values		Unit	Note / Test Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Host Authentication Computation Time	$T^{I)}_{HA}$			3.30	ms	

Table 17 Host Authentication Response Computation Time

1) Min. value here refers to the host needing to wait at least max (T_{HA}) before accessing the device for the response value. Max value here is optional (theoretically, the host can wait as long as it requires before reading back the response value) but this is provided for the host opting to time-out the readback process as a sign for abnormal activity.

5.11 ECC Authentication Response Computation Time

Table 18 ECC Authentication Response Computation Time

Parameter	Symbol		Values		Unit	Note / Test Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Response Computation Time ECCE-163	$T^{I)}_{_{ m ECCE163}}$			60.0	ms	

 Min. value here refers to the host needing to wait at least max (T_{ECCS163}) before accessing the device for the response value. Max value here is optional (theoretically, the host can wait as long as it requires before reading back the response value) but this is provided for the host opting to time-out the readback process as a sign for abnormal activity.

5.12 NVM Characteristics

Table 19NVM Characteristics

Parameter	Cumhal		Values		Unit	Note /
	Symbol	Min.	Тур.	Max.		Test Condition
NVM endurance	$N_{ m cyc}$			500,000	Cycles	25°C
NVM retention	$T_{ m retent}$			10	years	25°C
NVM programming time	t _{PROG}		4.59	5.1	ms	25°C
NVM programming time for MACCRx command	t _{prog, maccrx}			12.5	ms	

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Appendix

6 Appendix

[1] UM10204, I2C-Bus Specification and User Manual, NXP Semiconductors, Rev 6.00, 04 April 2014





Revision history

Document version	Date of release	Description of changes
1.0	2021-02-24	Initial Public Version (preliminary).
1.1	2021-12-12	Product name renamed from Authenticate IDoT to Authenticate S Updated Electrical Characteristics and minor typos

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